

PATENT ASSIGNMENT

Electronic Version v1.1

Stylesheet Version v1.1

SUBMISSION TYPE:	NEW ASSIGNMENT								
NATURE OF CONVEYANCE:	ASSIGNMENT								
CONVEYING PARTY DATA									
<table border="1"><thead><tr><th>Name</th><th>Execution Date</th></tr></thead><tbody><tr><td>HARUHIKO MASUDA</td><td>05/20/2004</td></tr><tr><td>SHINETSU HARADA</td><td>05/20/2004</td></tr></tbody></table>		Name	Execution Date	HARUHIKO MASUDA	05/20/2004	SHINETSU HARADA	05/20/2004		
Name	Execution Date								
HARUHIKO MASUDA	05/20/2004								
SHINETSU HARADA	05/20/2004								
RECEIVING PARTY DATA									
<table border="1"><tr><td>Name:</td><td>SUMITOMO BAKELITE COMPANY LIMITED</td></tr><tr><td>Street Address:</td><td>5-8, HIGASHISHINAGAWA-2-CHOME</td></tr><tr><td>City:</td><td>SHINAGAWA-KU, TOKYO</td></tr><tr><td>State/Country:</td><td>JAPAN</td></tr></table>		Name:	SUMITOMO BAKELITE COMPANY LIMITED	Street Address:	5-8, HIGASHISHINAGAWA-2-CHOME	City:	SHINAGAWA-KU, TOKYO	State/Country:	JAPAN
Name:	SUMITOMO BAKELITE COMPANY LIMITED								
Street Address:	5-8, HIGASHISHINAGAWA-2-CHOME								
City:	SHINAGAWA-KU, TOKYO								
State/Country:	JAPAN								
PROPERTY NUMBERS Total: 1									
<table border="1"><thead><tr><th>Property Type</th><th>Number</th></tr></thead><tbody><tr><td>Application Number:</td><td>10498162</td></tr></tbody></table>		Property Type	Number	Application Number:	10498162				
Property Type	Number								
Application Number:	10498162								
CORRESPONDENCE DATA									
Fax Number: (404)685-6948 <i>Correspondence will be sent via US Mail when the fax attempt is unsuccessful.</i>									
Phone: 4048153593									
Email: lkimsey@sgrlaw.com									
Correspondent Name: Robert G. Weilacher, Esq.									
Address Line 1: 1230 Peachtree Street, N.E.									
Address Line 2: Suite 3100, Promenade II									
Address Line 4: Atlanta, GEORGIA 30309-3592									
NAME OF SUBMITTER:	Robert G. Weilacher								
Total Attachments: 1 source=033036080p1#page1.tif									

OP \$40.00 10498162

W 0736-01
(*)

ASSIGNMENT

As a below named inventor, I hereby declare that:

IN CONSIDERATION of the sum of One Dollar(\$1.00) or the equivalent thereof, and other good and valuable consideration paid to me citizen of Japan by SUMITOMO BAKELITE COMPANY LIMITED, a corporation organized under the laws of Japan, located at 5-8, Higashishinagawa-2-chome, Shinagawa-ku, Tokyo, Japan, receipt of which is hereby acknowledged I do hereby sell and assign to said SUMITOMO BAKELITE COMPANY LIMITED, its successors and assigns, all my right, title and interest, in and for the United States of America, in and to

"CLIP DEVICE FOR ENDOSCOPE AND CLIP FOR ENDOSCOPE FOR USE THEREIN"

invented by me (if only one is named below) or us (if plural inventors are named below) and described in the application for United States Letters Patent therefor, executed on even date herewith,

and all United States Letters Patent which may be granted therefor, and all divisions, continuations and extensions thereof, the said interest being the entire ownership of the said Letters Patent when granted, to be held and enjoyed by said SUMITOMO BAKELITE COMPANY LIMITED, its successors, assigns or other legal representatives, to the full end of term for which said Letters Patent may be granted, as fully and entirely as the same would have been held and enjoyed by me or us if this assignment and sale had not been made;

And I hereby agree to sign and execute any further documents or instruments which may be necessary, lawful, and proper in the prosecution of the above-named application or in the preparation and prosecution of any continuing, continuation-in-part, substitute, divisional, renewal, reviewed or reissue applications or in any amendment, extension, or interference proceedings, or otherwise to secure the title thereto in said assignee;

And I do hereby authorize and request the Commissioner of Patents to issue said Letters Patent to said SUMITOMO BAKELITE COMPANY LIMITED.

Signed on the date(s) indicated aside signatures:

INVENTOR(S) (発明者フルネームサイン)	Date Signed (署名日)	WITNESSES (立会人サイン)
1) <u>Haruhiko Masuda</u> Haruhiko MASUDA	May 20, 2004	
2) <u>Shinetsu Harata</u> Shinetsu HARADA	May 20, 2004	
3) _____	_____	_____
4) _____	_____	_____
5) _____	_____	_____
6) _____	_____	_____
7) _____	_____	_____
8) _____	_____	_____

9) _____

PATENT